

Schottky Barrier Diode

BAS70-04L

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

Features

- Extremely Fast Switching Speed
- Low Forward Voltage
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 150°C unless otherwise noted)

| Rating | Symbol | Value | Unit |
|---|------------------|-------|------|
| Forward Current | I _F | 70 | mA |
| Non-Repetitive Peak Forward Surge Current (t ≤ 1.0 s) | I _{FSM} | 100 | mA |
| Reverse Voltage | V _R | 70 | V |

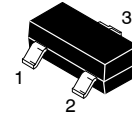
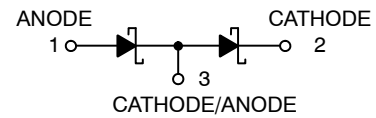
THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------------------------|----------------|-------------|
| Forward Power Dissipation @ T _A = 25°C Derate above 25°C | P _F | 225 1.8 | mW mW/°C |
| Thermal Resistance – Junction-to-Ambient (Note 1) (Note 2) | R _{θJA} | 508 311 | °C/W |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

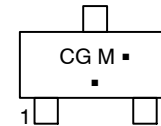
1. FR-4 @ minimum pad.
2. FR-4 @ 1.0 x 1.0 in pad.

70 VOLTS SCHOTTKY BARRIER DIODE



SOT-23 (TO-236)
CASE 318
STYLE 11

MARKING DIAGRAM



- CG = Specific Device Code
- M = Date Code*
- = Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping† |
|---------------|---------------------|-----------------------|
| BAS70-04LT1G | SOT-23 (Pb-Free) | 3000 / Tape & Reel |
| SBAS70-04LT1G | SOT-23 (Pb-Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, [BRD8011/D](#).

BAS70-04L

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|---|-------------|-------------|--------------------|---------------|
| Reverse Breakdown Voltage ($I_R = 10 \mu\text{A}$) | $V_{(BR)R}$ | 70 | - | V |
| Total Capacitance ($V_R = 0 \text{ V}$, $f = 1.0 \text{ MHz}$) | C_T | - | 2.0 | pF |
| Reverse Leakage ($V_R = 50 \text{ V}$) ($V_R = 70 \text{ V}$) | I_R | - - | 0.1 10 | μA |
| Forward Voltage ($I_F = 1.0 \text{ mA}$) ($I_F = 10 \text{ mA}$) ($I_F = 15 \text{ mA}$) | V_F | - - - | 410 750 1000 | mV |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

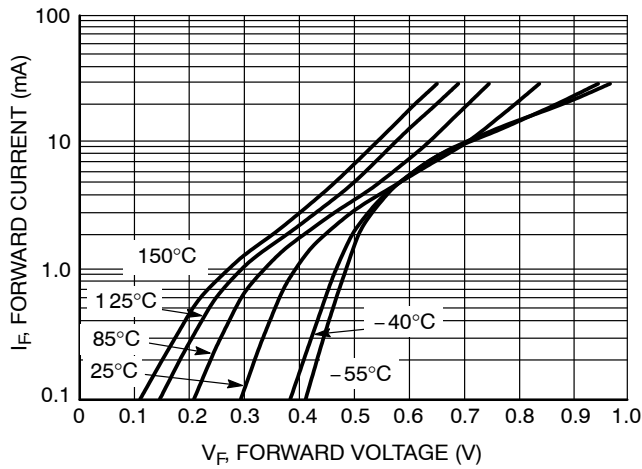


Figure 1. Typical Forward Voltage

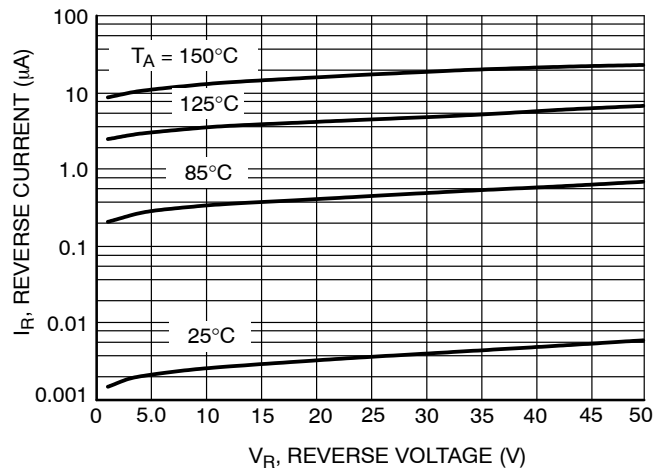


Figure 2. Reverse Current versus Reverse Voltage

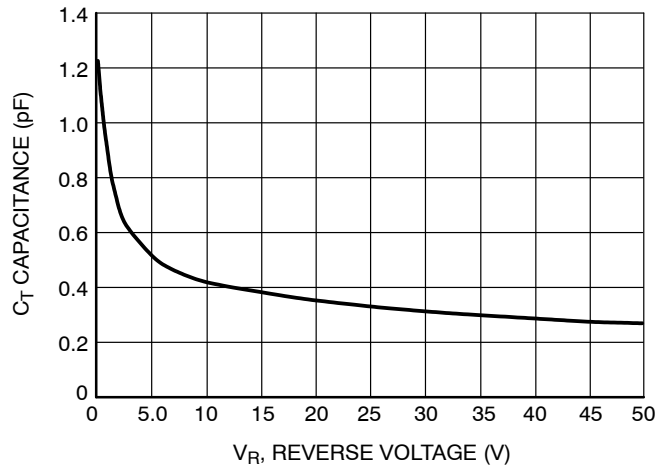
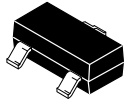


Figure 3. Typical Capacitance

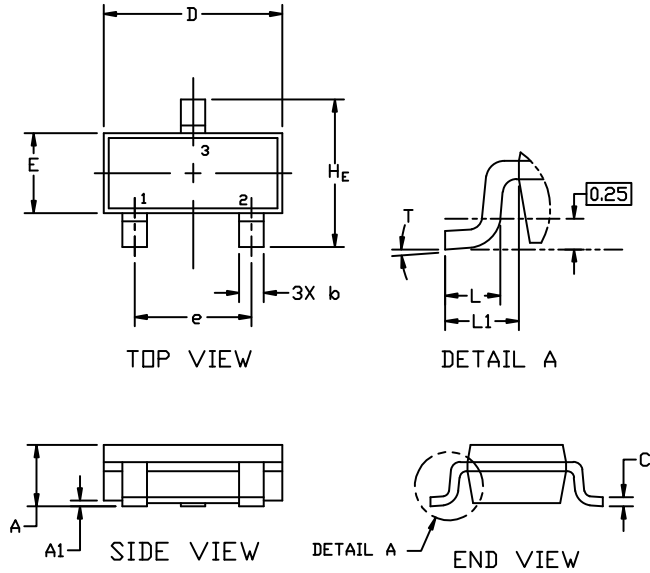
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SOT-23 (TO-236)
CASE 318
ISSUE AT

DATE 01 MAR 2023

SCALE 4:1



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

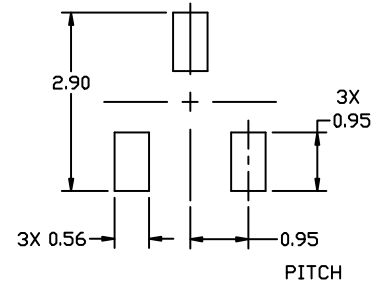
| DIM | MILLIMETERS | | | INCHES | | |
|----------------|-------------|------|------|--------|-------|-------|
| | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| A | 0.89 | 1.00 | 1.11 | 0.035 | 0.039 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.017 | 0.020 |
| c | 0.08 | 0.14 | 0.20 | 0.003 | 0.006 | 0.008 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.080 |
| L | 0.30 | 0.43 | 0.55 | 0.012 | 0.017 | 0.022 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.027 |
| H _E | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| T | 0° | --- | 10° | 0° | --- | 10° |

GENERIC MARKING DIAGRAM*



- XXX = Specific Device Code
- M = Date Code
- = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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**MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS**



**SOT-23 (TO-236)
CASE 318
ISSUE AT**

DATE 01 MAR 2023

- STYLE 1 THRU 5:
CANCELLED
- STYLE 6:
PIN 1. BASE
2. EMITTER
3. COLLECTOR
- STYLE 7:
PIN 1. EMITTER
2. BASE
3. COLLECTOR
- STYLE 8:
PIN 1. ANODE
2. NO CONNECTION
3. CATHODE
- STYLE 9:
PIN 1. ANODE
2. ANODE
3. CATHODE
- STYLE 10:
PIN 1. DRAIN
2. SOURCE
3. GATE
- STYLE 11:
PIN 1. ANODE
2. CATHODE
3. CATHODE-ANODE
- STYLE 12:
PIN 1. CATHODE
2. CATHODE
3. ANODE
- STYLE 13:
PIN 1. SOURCE
2. DRAIN
3. GATE
- STYLE 14:
PIN 1. CATHODE
2. GATE
3. ANODE
- STYLE 15:
PIN 1. GATE
2. CATHODE
3. ANODE
- STYLE 16:
PIN 1. ANODE
2. CATHODE
3. CATHODE
- STYLE 17:
PIN 1. NO CONNECTION
2. ANODE
3. CATHODE
- STYLE 18:
PIN 1. NO CONNECTION
2. CATHODE
3. ANODE
- STYLE 19:
PIN 1. CATHODE
2. ANODE
3. CATHODE-ANODE
- STYLE 20:
PIN 1. CATHODE
2. ANODE
3. GATE
- STYLE 21:
PIN 1. GATE
2. SOURCE
3. DRAIN
- STYLE 22:
PIN 1. RETURN
2. OUTPUT
3. INPUT
- STYLE 23:
PIN 1. ANODE
2. ANODE
3. CATHODE
- STYLE 24:
PIN 1. GATE
2. DRAIN
3. SOURCE
- STYLE 25:
PIN 1. ANODE
2. CATHODE
3. GATE
- STYLE 26:
PIN 1. CATHODE
2. ANODE
3. NO CONNECTION
- STYLE 27:
PIN 1. CATHODE
2. CATHODE
3. CATHODE
- STYLE 28:
PIN 1. ANODE
2. ANODE
3. ANODE

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